



Design of the Ladder Balconies



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2nd International Workshop on DEPFET

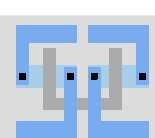
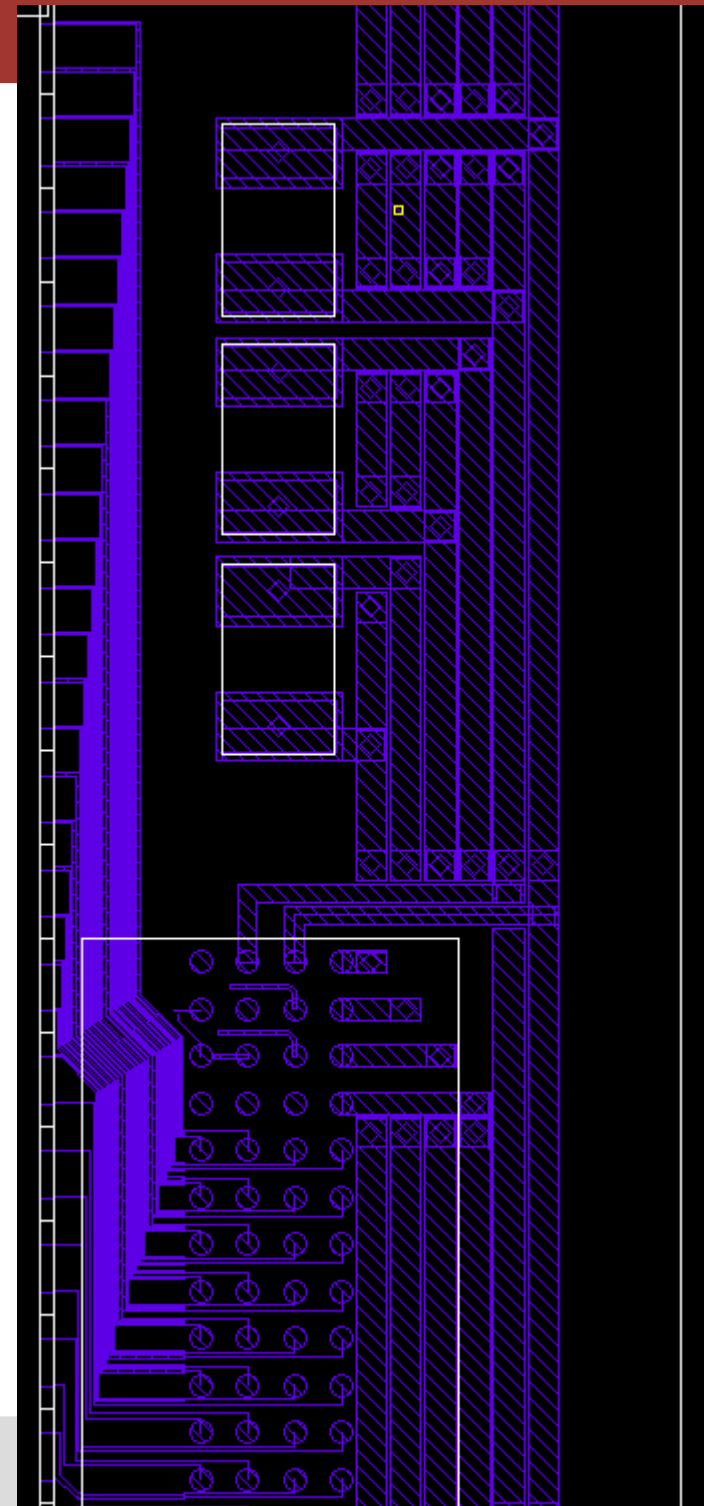
detectors and applications

Ringberg Castle

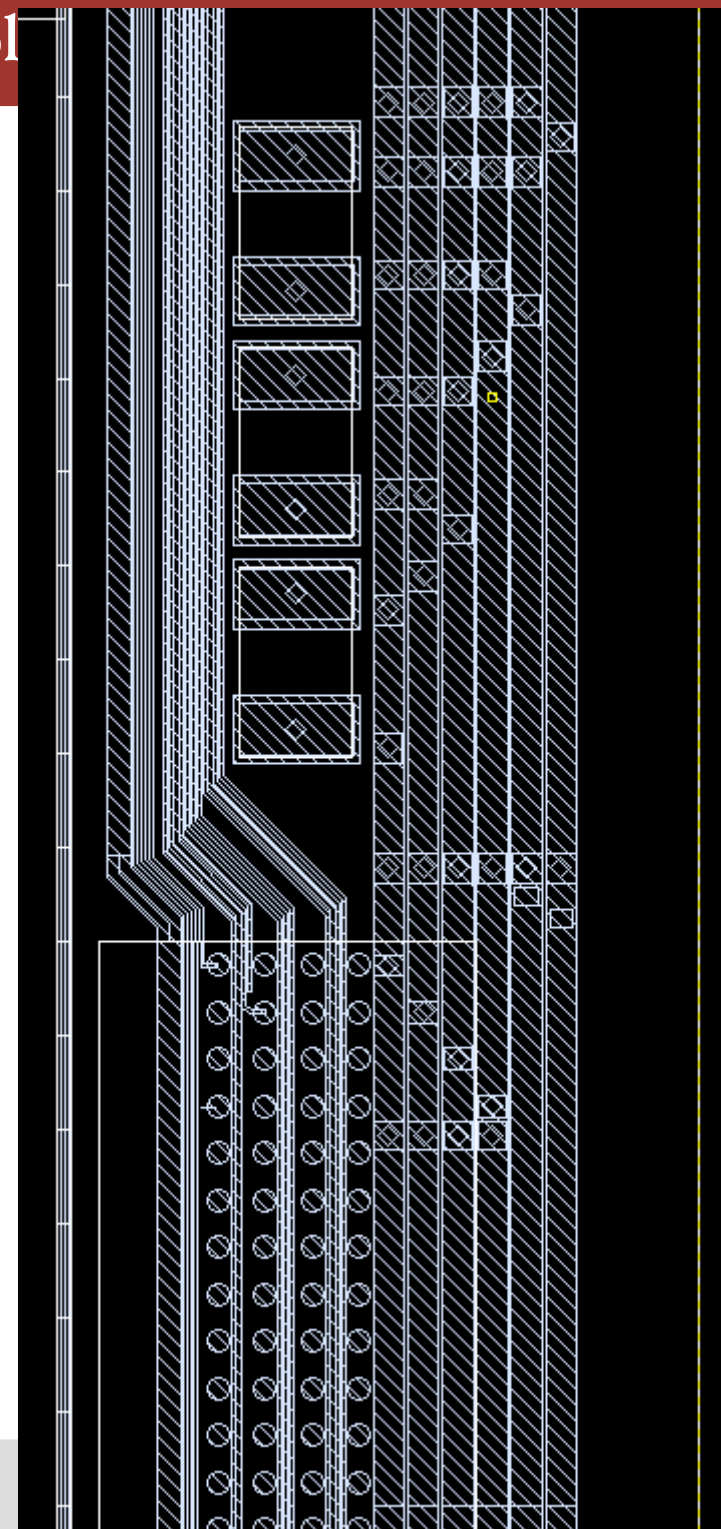
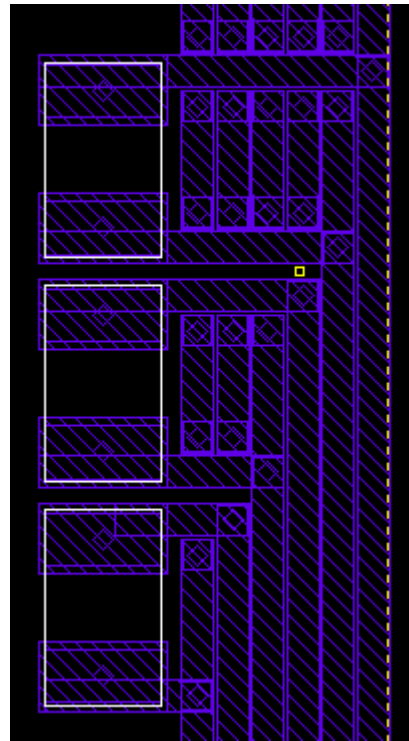
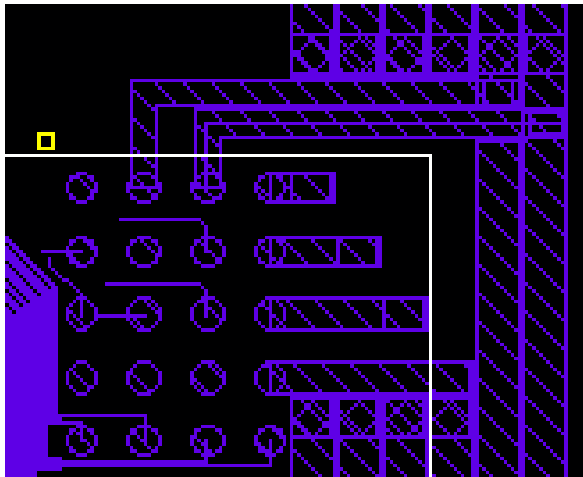
03. - 06.05.2009

Switcher Fanout

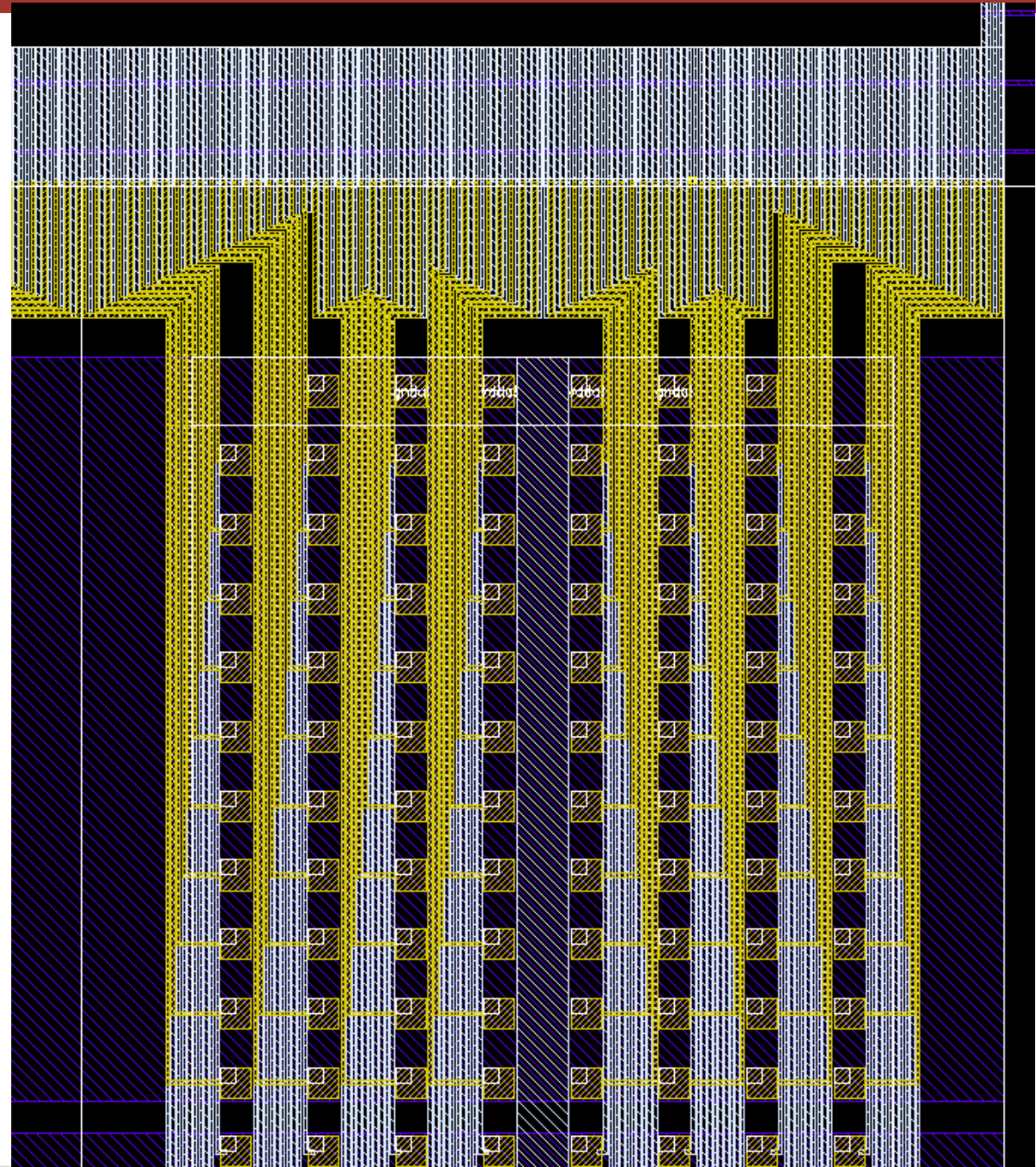
- 96 pads
 - 64 channels
 - 20 I/O Pads
 - 12 Power
- only metal1 used
- top part: 270 μm width
- bottom: 405 μm width
- balcony width (active \leftrightarrow power): 1610 μm
- free balcony: 390 μm
 - use for increased power trace width
 - width keepout???



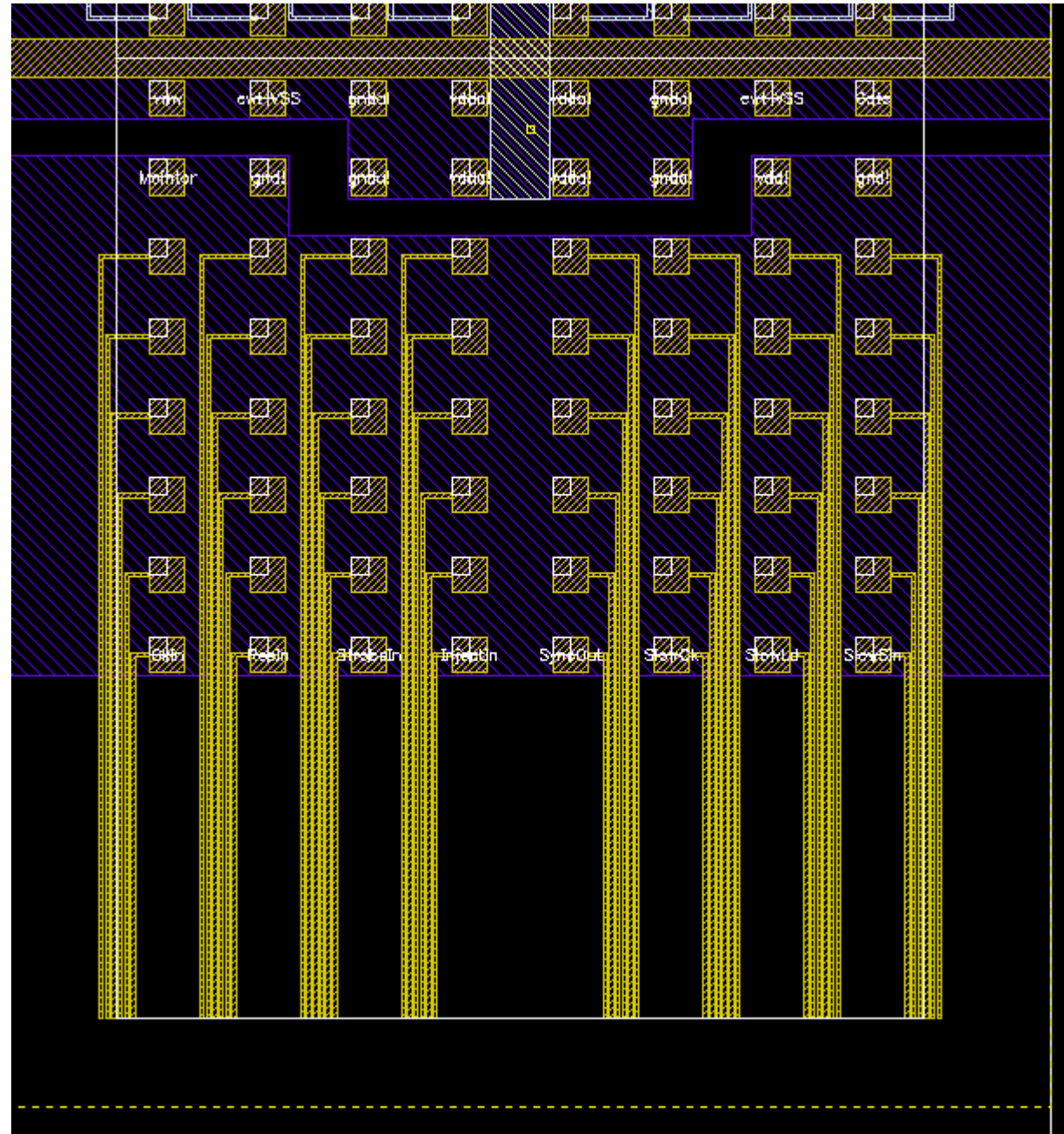
- supply traces 100 μ m
 - metal2 continuous
 - metal1 where possible
- 0201 capacitors
 - 2 for each supply per chip
 - 6,3V 100nF X5R
 - 10V 10nF X7R
 - 16V 3.3nF
 - 25V 100pF NP0



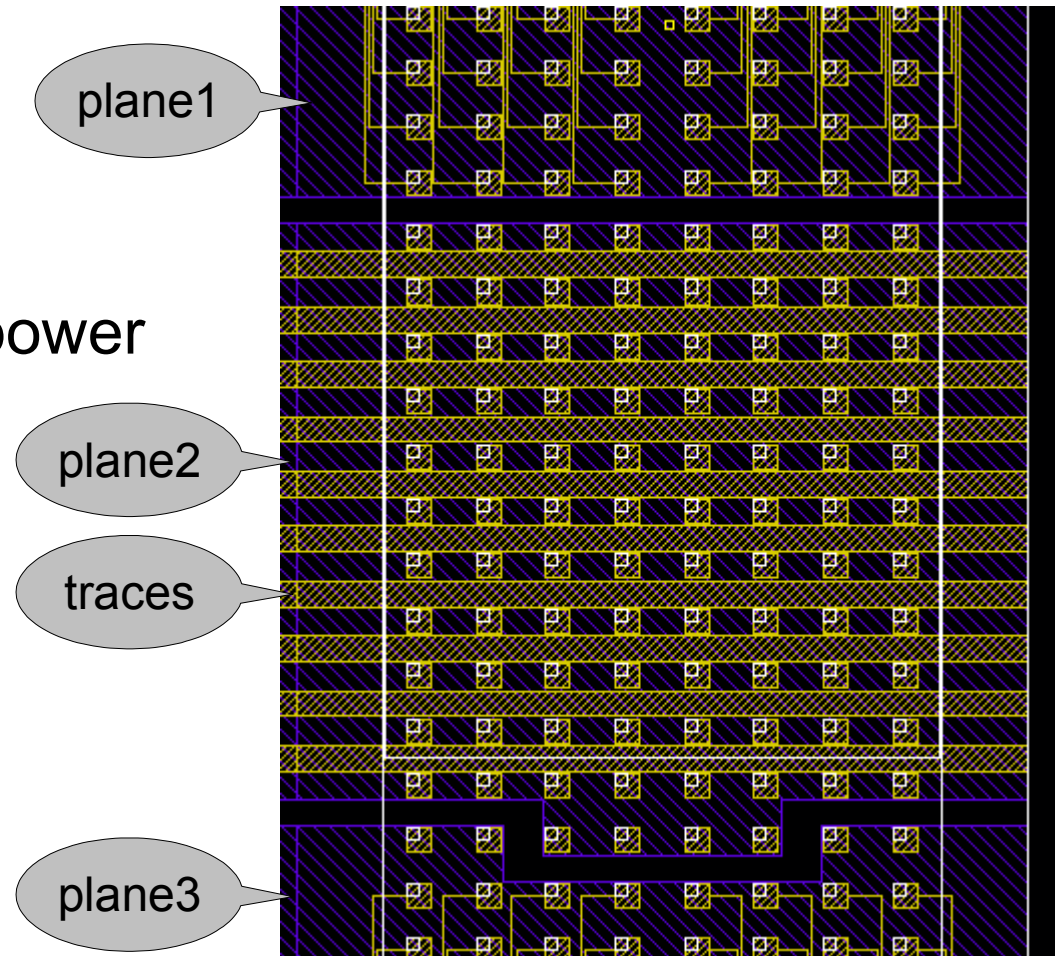
- 65 μm pads
- 190 μm pitch in x
- 150 μm pitch in y
- 2 metal layer
- 12 μm trace pitch
- 4,5mm x 1,5mm chip
- 2mm pitch



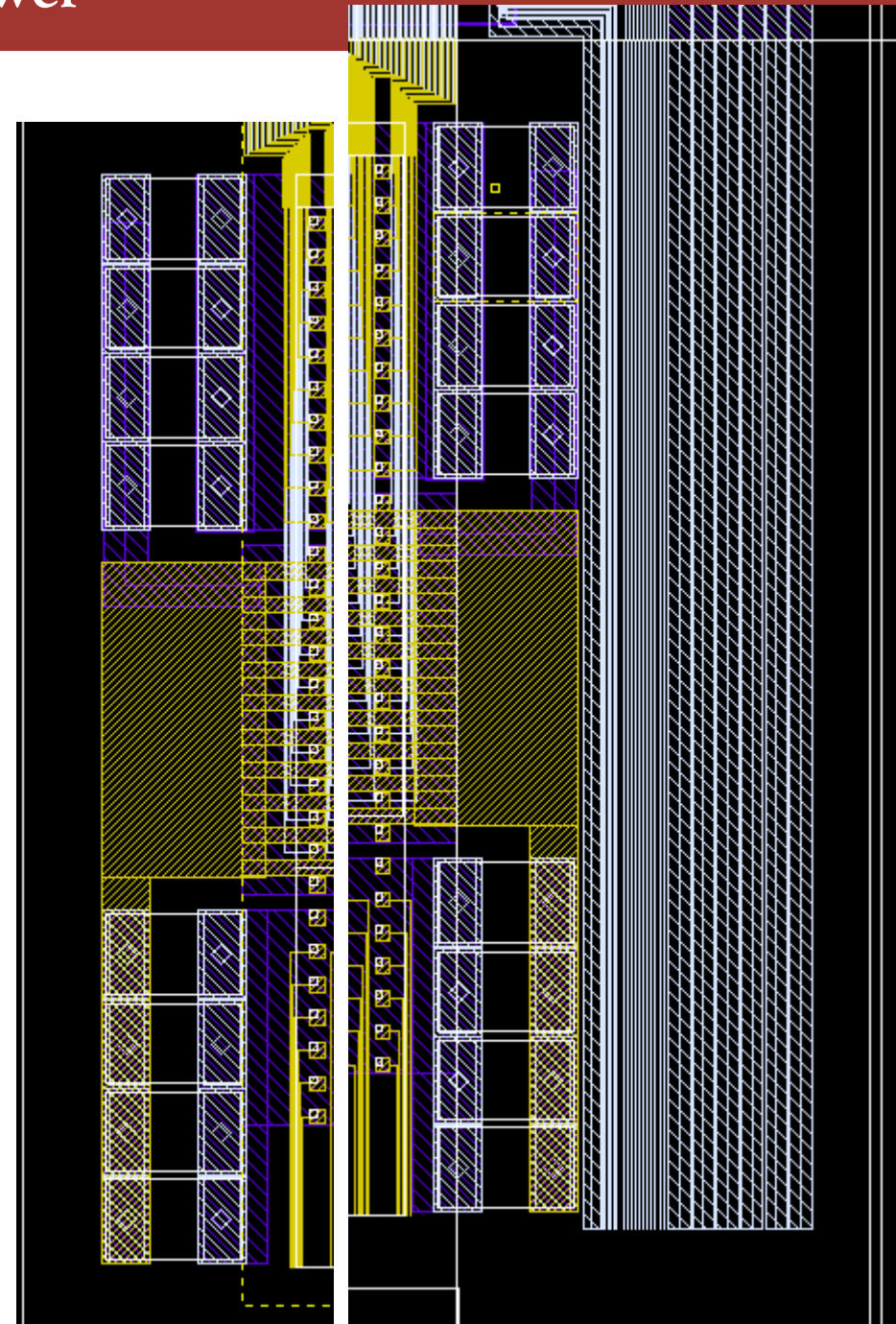
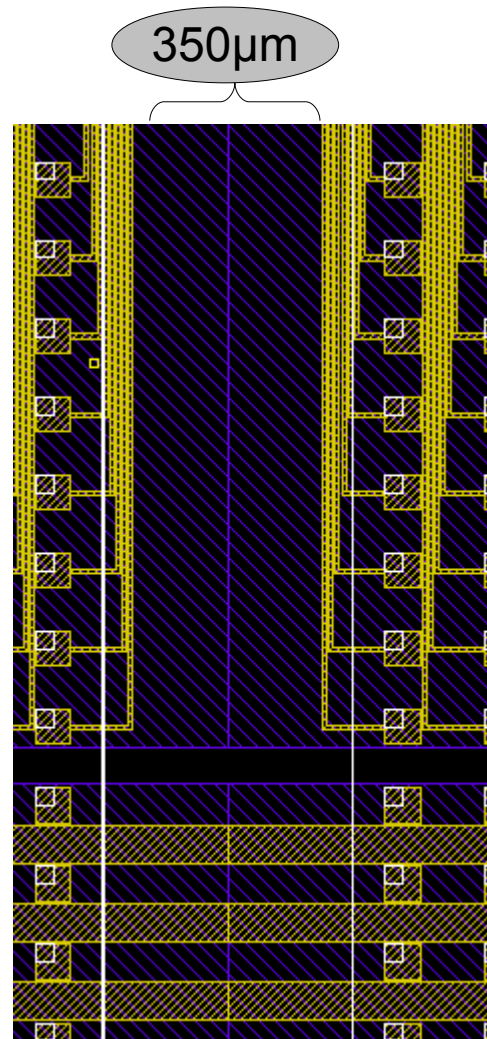
- 1 metal layer



- 4 power rails
- high power consumption: 600mA
- 1mm width needed
- 3 metal1 planes
- metal2 + metal3 traces
- separated analog + digital power



- use gap between fanout to wirebond supply
- area left of dcDs for decoupling



Thank you!